

"TOYOLAC" Plating Grade ABS Resin

TECHNICAL GUIDE

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1. INTRODUCTION

"TOYOLAC" is the trade name of Toray's thermoplastics that is known as ABS polymer (Arylonitrile-Butadiene-Styrene resin) in regular use for the past thirty years. "TOYOLAC" has lightness, toughness and attractive appearance, and ensures excellent mechanical, thermal, chemical, electrical properties and well balanced mold ability. It is used in wide range of applications including industrial material and household articles.

2. FEATURE OF "TOYOLAC" PLATING ABS

"TOYOLAC" Plating grade ABS is designed for plating applications particularly in automotive industry in which aesthetic appearance is strongly emphasized. This grade has successfully overcome several plating process problems such as crazing and weak plating adhesion which were encountered by general ABS. The most attractive characteristics of "TOYOLAC" plating grade is they offer balance properties of flow and impact strength yet with competitive price.

Feature	"TOYOLAC" PLATING GRADE	GENERAL ABS RESIN
Moldability	۵	٥
Mechanical Property	۵	٥
Plating Property	۵	Δ
Cost	0	۵



General Properties of plating grade "TOYOLAC" 315 X01, "TOYOLAC" 325 and "TOYOLAC" 335 MPL ABS are shown in below Table 1.

Property 代表物性	Test Method 试验法	Test Condition 试验条件	Units 单位	PLATING 电镀型		
				High Flow 高流 动	Standard 一般	High Flow High Impact 高流动 高抗冲击
			Type 型号	315	325	335
			Suffix 区分字符	X01		MPL
ISO STANDARD						
Melt Flow Rate 流 动系数	ISO 1133	220°C / 10 kg	g/10min	24	15	24
Charpy Impact Strength (notched) 缺ロ冲击强度	ISO 179/1eA	23°C / 50 %RH	kJ/m²	24	25	32
Deflection Temperature Under Load 热变形温度	ISO 75	1.8 MPa / 120°C/hr	°C	81	81	83
Tensile Strength 引张强度; 降伏点	ISO 527	50 mm/min	MPa	47	47	44
Tensile Elongation at Break 拉伸伸长率			%	>10	>10	>5
Flexural Strength 弯曲强度	- ISO 178	2 mm/min	MPa	69	69	67
Flexural Modulus 弯曲模数				2300	2280	2330
Density 比重	ISO 1183	23°C	kg/m ³	1040	1040	1040

Note: The above values are typical data for the products under specific test conditions and not intended for use as limiting specifications. 「以上数据^谨代表在特定条件下所得的测定值的代表例」

Table 1: Catalogue Properties Data



3. PROCESSING CONDITION

Drying

Commonly, ABS resin absorbs moisture in proportion to environmental humidity. The absorbing process of moisture is a reversible process. Therefore, moisture of wet pellets will be lost to environmental air with lower humidity. Dried pellets should absorb moisture until the amount touches equilibrium amount with the moisture in the air. The absorbing moisture content depends on the relative humidity in the air and how long the resin was exposed. While "TOYOLAC" ABS resin is exposed to humidity, the moisture is absorbed onto surface and into inside of the pellets itself, recycled materials or molded parts. Typical equilibrium moisture of "TOYOLAC" Plating Grade ABS is around $0.2 \sim 0.3\%$ at 23° C, 50%RH, and $0.5 \sim 0.6\%$ at 40° C, 95%RH. The rate of absorbed moisture depends on pellet size, shape and environmental temperature. Non-dried ABS resin can cause silver streak problem on molded parts. The recommendable moisture content for "TOYOLAC" Plating Grade ABS is less than 0.1%, more desirable is 0.05%. Generally, below drying conditions are recommended.



Figure 1: Drying Variable of "TOYOLAC" Plating Grade ABS



Injection Molding Condition

The most common trouble happens to ABS resin when undergone plating process is swelling of plating film. Apparently this trouble is mostly caused by improper molding condition which subsequently resulting to abnormal orientation of rubber in ABS resin. Thus, it is important to optimize molding condition to reduce rubber orientation in order to obtain good plated molded part. Below are three main parameters for reference. Please refer *Plating Peeling Strength* for the correlation of molding condition and plating film adhesion strength.

- Higher resin temperature
- Slower injection speed
- Higher mold temperature

Injection Barrel Temperature

Generally, the barrel temperature of injection molding machine should increase from the hopper to the nozzle gradually. "TOYOLAC" Plating Grade ABS starts softening at around $90 \sim 110^{\circ}$ C. Standard molding condition is shown as below.

Nozzle	Zone 4	Zone 3	Zone 2	Zone 1	Hopper
230 - 250 °C	220 - 230 °C				

It should be properly controlled according to the injection molding machines, the shapes and size of the products, and the mold structure. Excessive temperature than recommended above could result in discoloration or burn marks problems. These are signs of damage to the material. Melt temperature of resin should be between $250 \sim 260^{\circ}$ C. It should be checked frequently and maintained within above recommended range to prevent defect to appearance and mechanical properties. Besides, too low temperature under hopper might cause injection screw to drag air into barrel and resulted silver streak problem. If shutdown is required, remove the material from the machine and purge out completely to avoid burning trouble.



Injection Speed & Pressure

Injection speeds will depend on products shape, gate structure and runner dimensions. Basically moderate injection speed is preferable in order to prevent orientation of rubber particles due to excessive sheer. Thus, the basic concept to avoid excessive rubber orientation is to slow down the flow front speed. The relationship of flow front speed and injection speed is illustrated in following formula.

$$V = Q / A = (S \times VS) / A$$

- V : Flow front speed (cm/s)
- Vs : Injection speed (screw forward speed) (cm/s)
- Q : Injection ratio (cm³/s)
- A : Channel cross section area (cm²)
- S : Screw cross section area (cm²)



Injection Speed Inetrchange Position

Figure 2: Injection Molding Parameter Setting

Injection speed is reduced at gate area but insufficient injection speed when entering the product area with large cross section area channel will induce wavy flow mark, weld line and other molding defects. Thus, the most effective method to optimize molding parameters setting is to determine the flow front speed rather than injection speed (screw forward speed). Injection speed is reduced when approaching the product rear area to prevent material burnt caused by adiabatic compression.



Mold Temperature

The mold temperature affects the surface quality and the level of residual stress in the molded products. To provide a molded product having excellent surface finish, less residual stress and lesser rubber ovality, the mold temperature should be controlled >60°C. However, higher mold temperature may cause longer cycle time and warpage problem. Excessive mold temperature should be avoided.

The keys molding conditions to achieve good plated molded part are summarized in Table 2.

Molding Process	Condition
Mold release agent	Totally prohibited (eg: silicon type)
Injection machine cylinder temperature	Slightly higher than normal ABS resin setting (230 -250°C)
Mold temperature	Higher side (60 - 80 °C)
Injection speed	At slower speed
Holding pressure	At lower side and shorter time

Table 2: Optimum Injection molding condition for "TOYOLAC" Plating Grade ABS

Purging

General maintenance and equipment cleaning should include frequent purging with natural color ABS resin or AS resin. If prolonged shut-down is required, reduce barrel temperature less than 150°C, remove the material from the injection machine and purge with natural ABS resin or AS resin. Continue this operation until hopper is empty throughout and confirm barrel temperature has been dropped less than 150°C.

Regrind

Runners, sprues and shot-shots of "TOYOLAC" Plating resin molded under proper molding conditions can be used for recycle materials. Those non-degraded regrind up to a 20% can be reprocessed with fresh pellets of the same grade. Please do not mix it up with other grades of "TOYOLAC" resin or other plastics. Drying is necessary before reprocessing.



5. PLATING PROCESS

Basic Schematic Illustration



Figure 3: Basic schematic illustration of plating process



ABS Resin Morphology

(1) ABS resin molded part surface area morphology before etching



(3) ABS resin molded part surface area morphology upon chemically plated by Ni



Figure 4: Plating film peeling strength analysis via Transmission Electron Microscope (TEM)



Effect of ABS Resin Morphology



Suitable morphology for plating process. Round shape rubber particles give round craters after etching which provide good anchoring effect during plating process. Less rubber orientation achieved via proper injection molding conditions setting.



Flat oval shape rubber particles indicate strong orientation. Molded part surface craters formed after etching are shallow thus weak anchoring effect is expected. Modification in molding conditions or product shape is necessary to avoid defect during plating process.



Molded part surface shows deep penetrating craters into ABS resin caused by over etching. Etched surface becomes brittle and no suitable anchoring crater is observed. Over etching might cause by severe plating condition (eg. excessive etching) or improper plastics resin selection.

Figure 5: ABS Resin Morphology Effects on Plating Process via TEM



Important Notes:

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2. The material described here is not recommended for medical application involving any implantation inside the human body. Safety Data Sheet (SDS) for the materials concerned should be referred to before any use.